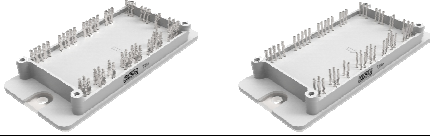
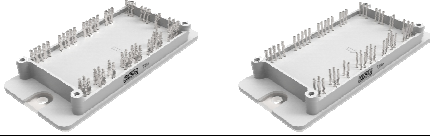
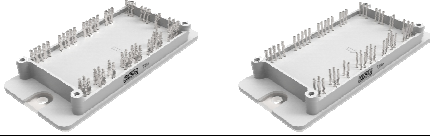
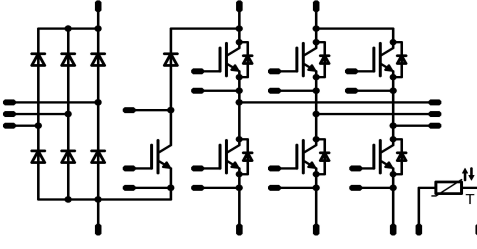
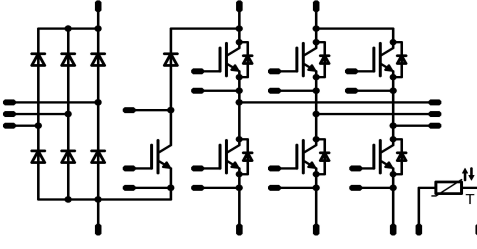
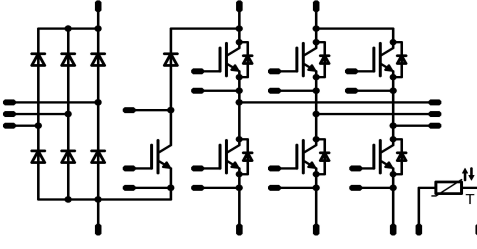




<b>flow PIM 2 3rd</b>	<b>1200 V / 50 A</b>				
<table border="1" style="width: 100%; border-collapse: collapse;"> <tr style="background-color: #ccc;"> <th style="text-align: center;">Features</th> </tr> <tr> <td style="padding: 5px;"> <ul style="list-style-type: none"> <li>3~rectifier,BRC,Inverter, NTC</li> <li>Very Compact housing, easy to route</li> <li>IGBT4/ EmCon4 technology for low saturation losses and improved EMC behavior</li> </ul> </td> </tr> </table>	Features	<ul style="list-style-type: none"> <li>3~rectifier,BRC,Inverter, NTC</li> <li>Very Compact housing, easy to route</li> <li>IGBT4/ EmCon4 technology for low saturation losses and improved EMC behavior</li> </ul>	<table border="1" style="width: 100%; border-collapse: collapse;"> <tr style="background-color: #ccc;"> <th style="text-align: center;">flow 2 housing</th> </tr> <tr> <td style="text-align: center; padding: 5px;">  </td> </tr> </table>	flow 2 housing	
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flow 2 housing					
					
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Types					
<ul style="list-style-type: none"> <li>V23990-P768-A-PM</li> <li>V23990-P768-AY-PM</li> </ul>					

## Maximum Ratings

T<sub>j</sub>=25°C, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
<b>Input Rectifier Diode</b>				
Repetitive peak reverse voltage	V <sub>RRM</sub>		1600	V
Forward current	I <sub>FAV</sub>	DC current T <sub>h</sub> =80°C T <sub>c</sub> =80°C	80 80	A
Surge forward current	I <sub>FSM</sub>	t <sub>p</sub> =10ms T <sub>j</sub> =25°C	700	A
I <sup>2</sup> t-value	I <sup>2</sup> t		2450	A <sup>2</sup> s
Power dissipation	P <sub>tot</sub>	T <sub>j</sub> =T <sub>jmax</sub> T <sub>h</sub> =80°C T <sub>c</sub> =80°C	95 144	W
Maximum Junction Temperature	T <sub>jmax</sub>		150	°C

### Inverter IGBT

Collector-emitter break down voltage	V <sub>CE</sub>		1200	V
DC collector current	I <sub>C</sub>	T <sub>j</sub> =T <sub>jmax</sub> T <sub>h</sub> =80°C T <sub>c</sub> =80°C	60 75	A
Repetitive peak collector current	I <sub>Cpulse</sub>	t <sub>p</sub> limited by T <sub>jmax</sub>	150	A
Power dissipation	P <sub>tot</sub>	T <sub>j</sub> =T <sub>jmax</sub> T <sub>h</sub> =80°C T <sub>c</sub> =80°C	163 247	W
Gate-emitter peak voltage	V <sub>GE</sub>		±20	V
Short circuit ratings	t <sub>SC</sub> V <sub>CC</sub>	T <sub>j</sub> ≤150°C V <sub>GE</sub> =15V	10 900	µs V
Maximum Junction Temperature	T <sub>jmax</sub>		175	°C



## Maximum Ratings

T<sub>j</sub>=25°C, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
<b>Inverter FWD</b>				
Peak Repetitive Reverse Voltage	VRRM		1200	V
DC forward current	I <sub>F</sub>	T <sub>j</sub> =T <sub>j</sub> max T <sub>h</sub> =80°C T <sub>c</sub> =80°C	60 80	A
Repetitive peak forward current	I <sub>FRM</sub>	t <sub>p</sub> limited by T <sub>j</sub> max	100	A
Power dissipation	P <sub>tot</sub>	T <sub>j</sub> =T <sub>j</sub> max T <sub>h</sub> =80°C T <sub>c</sub> =80°C	114 173	W
Maximum Junction Temperature	T <sub>j</sub> max		175	°C

### Brake IGBT

Collector-emitter break down voltage	V <sub>CE</sub>		1200	V
DC collector current	I <sub>C</sub>	T <sub>j</sub> =T <sub>j</sub> max T <sub>h</sub> =80°C T <sub>c</sub> =80°C	44 45	A
Repetitive peak collector current	I <sub>Cpuls</sub>	t <sub>p</sub> limited by T <sub>j</sub> max	105	A
Power dissipation	P <sub>tot</sub>	T <sub>j</sub> =T <sub>j</sub> max T <sub>h</sub> =80°C T <sub>c</sub> =80°C	130 198	W
Gate-emitter peak voltage	V <sub>GE</sub>		±20	V
Short circuit ratings	t <sub>SC</sub> V <sub>CC</sub>	T <sub>j</sub> ≤150°C V <sub>GE</sub> =15V	10 900	μs V
Maximum Junction Temperature	T <sub>j</sub> max		175	°C

### Brake Inverse Diode

Peak Repetitive Reverse Voltage	V <sub>RRM</sub>		1200	V
DC forward current	I <sub>F</sub>	T <sub>j</sub> =T <sub>j</sub> max T <sub>h</sub> =80°C T <sub>c</sub> =80°C	10 10	A
Repetitive peak forward current	I <sub>FRM</sub>	t <sub>p</sub> limited by T <sub>j</sub> max	20	A
Brake Inverse Diode	P <sub>tot</sub>	T <sub>j</sub> =T <sub>j</sub> max T <sub>h</sub> =80°C T <sub>c</sub> =80°C	50 75	W
Maximum Junction Temperature	T <sub>j</sub> max		175	°C

### Brake FWD

Peak Repetitive Reverse Voltage	V <sub>RRM</sub>		1200	V
DC forward current	I <sub>F</sub>	T <sub>j</sub> =T <sub>j</sub> max T <sub>h</sub> =80°C T <sub>c</sub> =80°C	25 25	A
Repetitive peak forward current	I <sub>FRM</sub>	t <sub>p</sub> limited by T <sub>j</sub> max	50	A
Power dissipation	P <sub>tot</sub>	T <sub>j</sub> =T <sub>j</sub> max T <sub>h</sub> =80°C T <sub>c</sub> =80°C	75 114	W
Maximum Junction Temperature	T <sub>j</sub> max		175	°C



## Maximum Ratings

T<sub>j</sub>=25°C, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
<b>Thermal properties</b>				
Storage temperature	T <sub>stg</sub>		-40...+125	°C
Operation temperature under switching condition	T <sub>op</sub>		-40...+T <sub>jmax</sub> -25	°C
<b>Insulation properties</b>				
Insulation voltage	V <sub>is</sub>	t=1min	4000	V <sub>DC</sub>
Creepage distance			min 12,7	mm
Clearance			min 12,7	mm

## Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		$V_{GE}$ [V] or $V_{GS}$ [V]	$V_r$ [V] or $V_{CE}$ [V] or $V_{DS}$ [V]	$I_c$ [A] or $I_F$ [A] or $I_D$ [A]	$T_j$	Min	Typ	Max		

### Input Rectifier Diode

Forward voltage	$V_F$				50	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		1,1 1,05	1,7	V
Threshold voltage (for power loss calc. only)	$V_{to}$					$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		0,89 0,78		V
Slope resistance (for power loss calc. only)	$r_t$					$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		0,004 0,006		$\Omega$
Reverse current	$I_r$			1500		$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$			0,05 1,1	mA
Thermal resistance chip to heatsink	$R_{thJH}$	Thermal grease thickness $\leq 50\mu\text{m}$ $\lambda = 0,61 \text{ W/m}\cdot\text{K}$						0,74		K/W
Thermal resistance chip to case	$R_{thJC}$							0,49		

### Inverter IGBT

Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE}=V_{GE}$			0,0017	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$	5	5,8	6,5	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		50	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		1,86 2,3	2,3	V
Collector-emitter cut-off current incl. Diode	$I_{CES}$		0	1200		$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$			0,02	mA
Gate-emitter leakage current	$I_{GES}$		20	0		$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$			200	nA
Integrated Gate resistor	$R_{gInt}$							4		$\Omega$
Turn-on delay time	$t_{d(on)}$	$R_{goff}=8 \Omega$ $R_{gon}=8 \Omega$	$\pm 15$	600	50	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		104 100		ns
Rise time	$t_r$					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		19 23,8		
Turn-off delay time	$t_{d(off)}$					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		220 295		
Fall time	$t_f$					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		78 118		
Turn-on energy loss per pulse	$E_{on}$					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		2,86 4,5		
Turn-off energy loss per pulse	$E_{off}$	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		2,69 4,48						
Input capacitance	$C_{ies}$							2770		pF
Output capacitance	$C_{oss}$	$f=1\text{MHz}$	0	25		$T_j=25^\circ\text{C}$		205		
Reverse transfer capacitance	$C_{riss}$							160		
Gate charge	$Q_{Gate}$		$\pm 15$	960		$T_j=25^\circ\text{C}$		290		nC
Thermal resistance chip to heatsink	$R_{thJH}$							0,58		K/W
Thermal resistance chip to case	$R_{thJC}$	Thermal grease thickness $\leq 50\mu\text{m}$ $\lambda = 0,61 \text{ W/m}\cdot\text{K}$						0,38		
Coupled thermal resistance transistor-transistor	$R_{thJHT-T}$							0,1		
Coupled thermal resistance diode-transistor	$R_{thJHD-T}$							0,13		

### Inverter FWD

Diode forward voltage	$V_F$				50	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		1,75 1,71	2,2	V	
Peak reverse recovery current	$I_{RRM}$	$R_{gon}=8 \Omega$	$\pm 15$	600	50	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		65 82		A	
Reverse recovery time	$t_{rr}$					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		162 313			
Reverse recovered charge	$Q_{rr}$					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		4,62 9,95			$\mu\text{C}$
Peak rate of fall of recovery current	$di(\text{rec})_{\text{max}}/dt$					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		2298 1106			
Reverse recovered energy	$E_{rec}$					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$					1,92 3,98
Thermal resistance chip to heatsink	$R_{thJH}$	Thermal grease thickness $\leq 50\mu\text{m}$ $\lambda = 0,61 \text{ W/m}\cdot\text{K}$						0,83		K/W	
Thermal resistance chip to case	$R_{thJC}$							0,55			
Coupled thermal resistance transistor-diode	$R_{thJHT-D}$							0,12			

## Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		$V_{GE}$ [V] or $V_{GS}$ [V]	$V_r$ [V] or $V_{CE}$ [V] or $V_{DS}$ [V]	$I_c$ [A] or $I_F$ [A] or $I_D$ [A]	$T_j$	Min	Typ	Max		
<b>Brake IGBT</b>										
Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE}=V_{GE}$			0,0012	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$	5	5,8	6,5	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		35	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		1,91 2,37	2,3	V
Collector-emitter cut-off incl diode	$I_{CES}$		0	1200		$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$			0,25	mA
Gate-emitter leakage current	$I_{GES}$		20	0		$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$			200	nA
Integrated Gate resistor	$R_{gint}$							none		$\Omega$
Turn-on delay time	$t_{d(on)}$	$R_{goff}=16 \Omega$ $R_{gon}=16 \Omega$	$\pm 15$	600	35	$T_j=25^\circ\text{C}$		92		ns
Rise time	$t_r$					$T_j=150^\circ\text{C}$		84		
Turn-off delay time	$t_{d(off)}$					$T_j=25^\circ\text{C}$		21		
Fall time	$t_f$					$T_j=150^\circ\text{C}$		24		
Turn-on energy loss per pulse	$E_{on}$					$T_j=25^\circ\text{C}$		182		
Turn-off energy loss per pulse	$E_{off}$					$T_j=150^\circ\text{C}$		253		
Input capacitance	$C_{ies}$	$f=1\text{MHz}$	0	25		$T_j=25^\circ\text{C}$		1950		pF
Output capacitance	$C_{oss}$							155		
Reverse transfer capacitance	$C_{rss}$							115		
Gate charge	$Q_{Gate}$		$\pm 15$	960		$T_j=25^\circ\text{C}$		200		nC
Thermal resistance chip to heatsink	$R_{thJH}$	Thermal grease thickness $\leq 50\mu\text{m}$						0,73		K/W
Thermal resistance chip to case	$R_{thJC}$	$\lambda = 0,61 \text{ W/m}\cdot\text{K}$						0,48		
<b>Brake Inverse Diode</b>										
Diode forward voltage	$V_F$				10	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$	1,1	1,89 1,8	2,1	V
Thermal resistance chip to heatsink	$R_{thJH}$	Thermal grease thickness $\leq 50\mu\text{m}$						1,86		K/W
Thermal resistance chip to case	$R_{thJC}$	$\lambda = 0,61 \text{ W/m}\cdot\text{K}$						1,23		K/W
<b>Brake FWD</b>										
Diode forward voltage	$V_F$				25	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		1,9 1,88	2,2	V
Reverse leakage current	$I_r$		$\pm 15$	600	35	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$			10	$\mu\text{A}$
Peak reverse recovery current	$I_{RRM}$	$R_{gon}=16 \Omega$	$\pm 15$	600	35	$T_j=25^\circ\text{C}$		27,41		A
Reverse recovery time	$t_{rr}$					$T_j=150^\circ\text{C}$		41,04		
Reverse recovered charge	$Q_{rr}$					$T_j=25^\circ\text{C}$		300		
Peak rate of fall of recovery current	$di(rec)_{max}/dt$					$T_j=150^\circ\text{C}$		322		
Reverse recovery energy	$E_{rec}$					$T_j=25^\circ\text{C}$		2,68		
						$T_j=150^\circ\text{C}$		5,19		
Thermal resistance chip to heatsink	$R_{thJH}$	Thermal grease thickness $\leq 50\mu\text{m}$						1,24		K/W
Thermal resistance chip to case	$R_{thJC}$	$\lambda = 0,61 \text{ W/m}\cdot\text{K}$						0,82		
<b>Thermistor</b>										
Rated resistance	$R_{25}$					$T_j=25^\circ\text{C}$		22		k $\Omega$
Deviation of R100	$D_{R/R}$	$R_{100}=1486 \Omega$				$T_c=100^\circ\text{C}$	-12		12	%
Power dissipation	$P$					$T_j=25^\circ\text{C}$		200		mW
Power dissipation constant						$T_j=25^\circ\text{C}$		2		mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 3\%$				$T_j=25^\circ\text{C}$		3950		K
B-value	$B_{(25/100)}$	Tol. $\pm 3\%$				$T_j=25^\circ\text{C}$		3998		K
Vincotech NTC Reference									B	

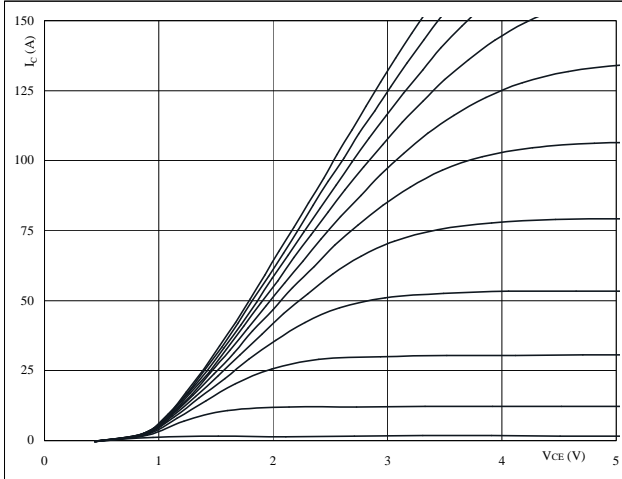


# Output Inverter

**Figure 1** Output inverter IGBT

**Typical output characteristics**

$I_C = f(V_{CE})$

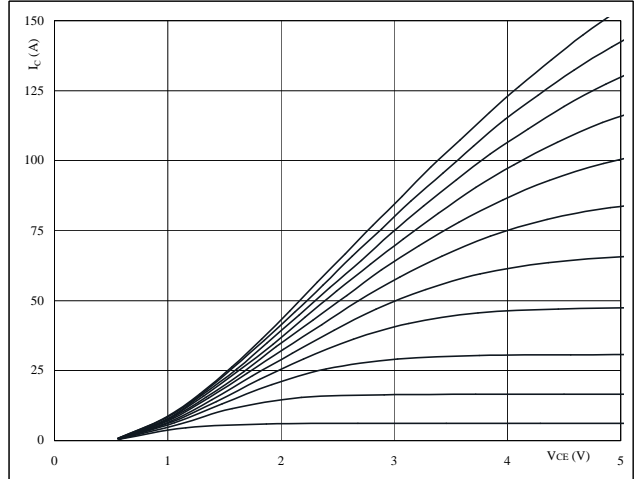


**At**  
 $t_p = 250 \mu s$   
 $T_j = 25 \text{ }^\circ C$   
VGE from 7 V to 17 V in steps of 1 V

**Figure 2** Output inverter IGBT

**Typical output characteristics**

$I_C = f(V_{CE})$

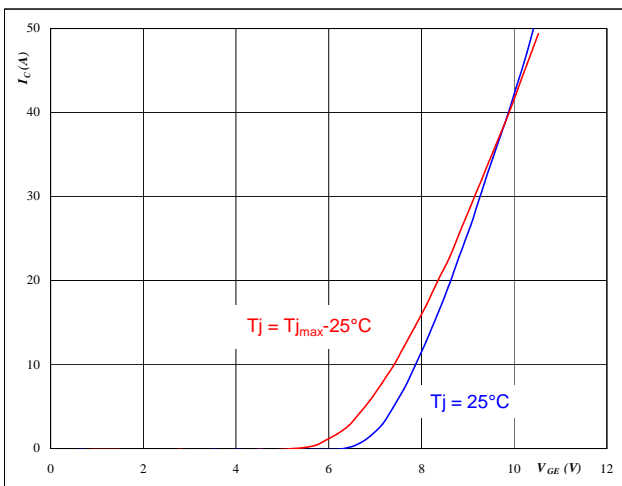


**At**  
 $t_p = 250 \mu s$   
 $T_j = 150 \text{ }^\circ C$   
VGE from 7 V to 17 V in steps of 1 V

**Figure 3** Output inverter IGBT

**Typical transfer characteristics**

$I_C = f(V_{GE})$

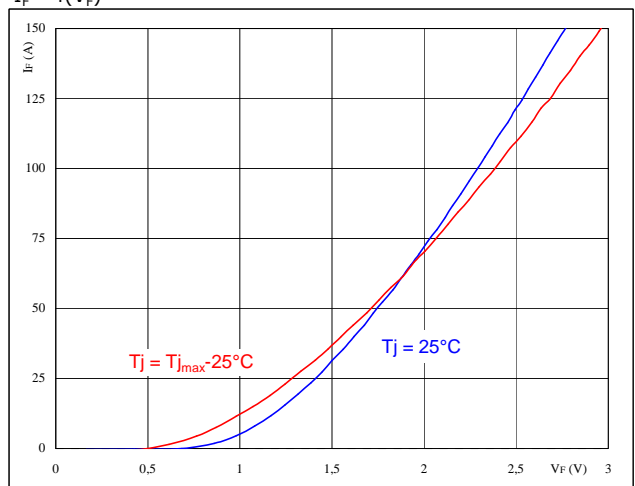


**At**  
 $t_p = 250 \mu s$   
 $V_{CE} = 10 V$

**Figure 4** Output inverter FWD

**Typical diode forward current as a function of forward voltage**

$I_F = f(V_F)$



**At**  
 $t_p = 250 \mu s$

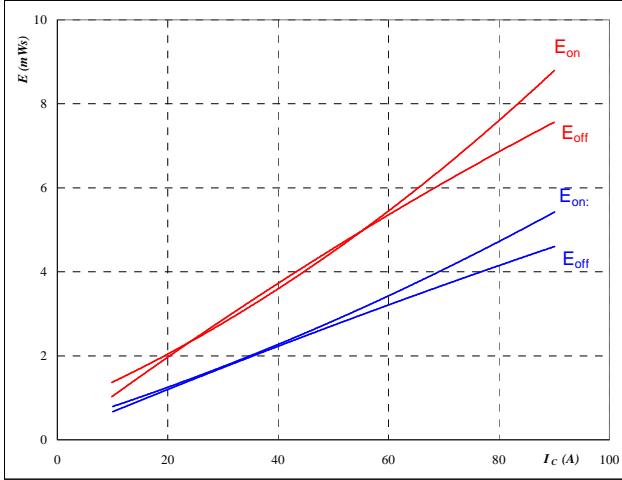


# Output Inverter

**Figure 5** Output inverter IGBT

**Typical switching energy losses as a function of collector current**

$E = f(I_C)$



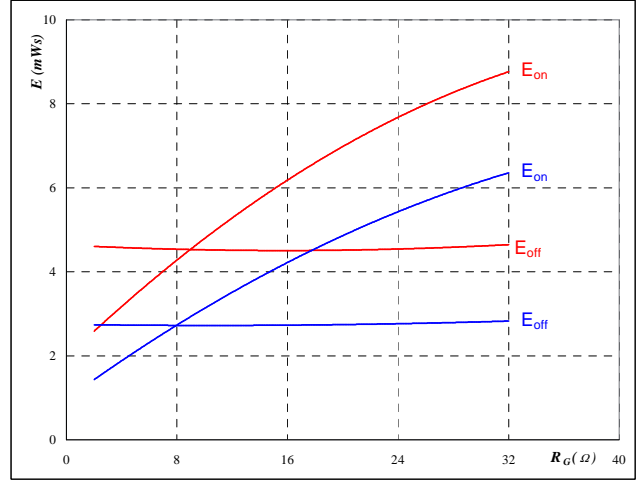
With an inductive load at

- T<sub>j</sub> = 25/150 °C
- V<sub>CE</sub> = 600 V
- V<sub>GE</sub> = ±15 V
- R<sub>gon</sub> = 8 Ω
- R<sub>goff</sub> = 8 Ω

**Figure 6** Output inverter IGBT

**Typical switching energy losses as a function of gate resistor**

$E = f(R_G)$



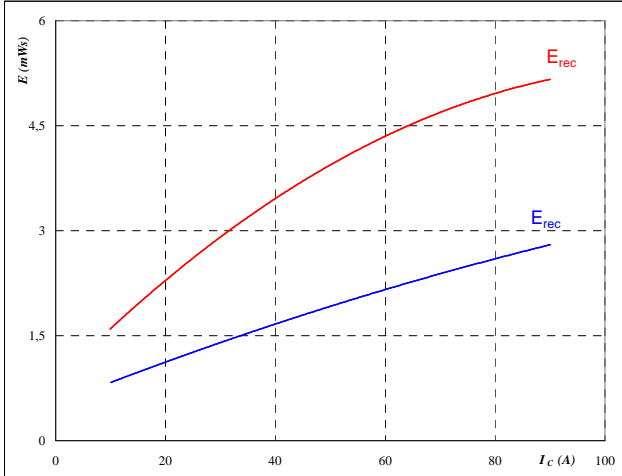
With an inductive load at

- T<sub>j</sub> = 25/150 °C
- V<sub>CE</sub> = 600 V
- V<sub>GE</sub> = ±15 V
- I<sub>C</sub> = 50 A

**Figure 7** Output inverter IGBT

**Typical reverse recovery energy loss as a function of collector current**

$E_{rec} = f(I_C)$



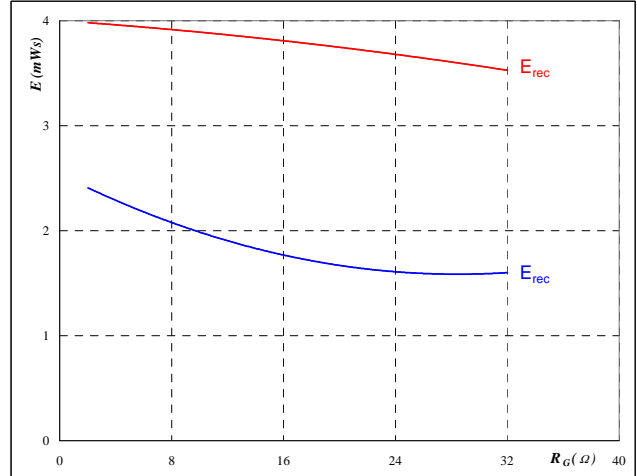
With an inductive load at

- T<sub>j</sub> = 25/150 °C
- V<sub>CE</sub> = 600 V
- V<sub>GE</sub> = ±15 V
- R<sub>gon</sub> = 8 Ω

**Figure 8** Output inverter IGBT

**Typical reverse recovery energy loss as a function of gate resistor**

$E_{rec} = f(R_G)$



With an inductive load at

- T<sub>j</sub> = 25/150 °C
- V<sub>CE</sub> = 600 V
- V<sub>GE</sub> = ±15 V
- I<sub>C</sub> = 50 A

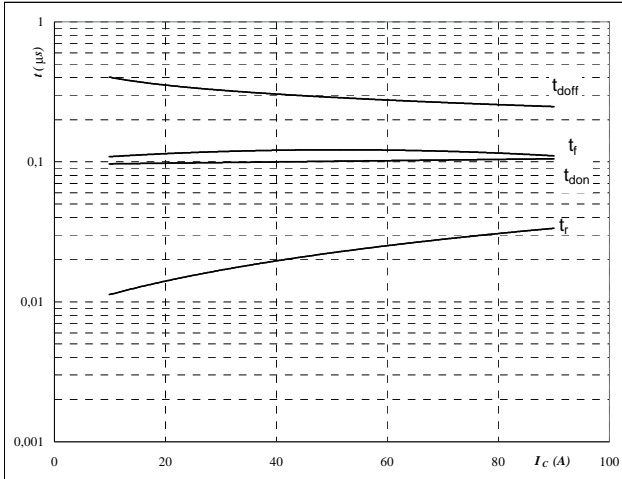


# Output Inverter

**Figure 9** Output inverter IGBT

Typical switching times as a function of collector current

$t = f(I_C)$



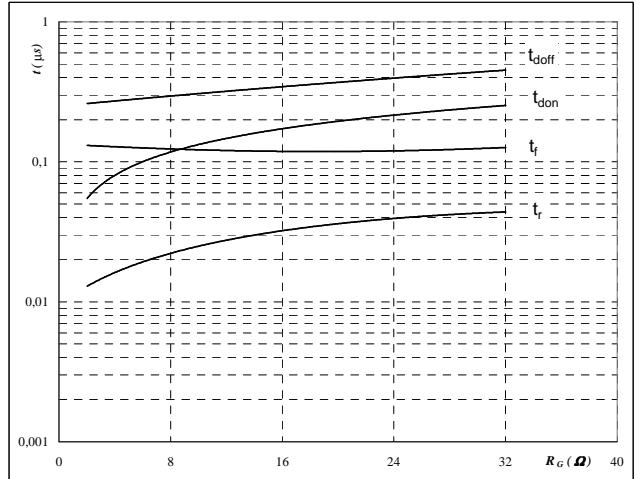
With an inductive load at

- $T_j = 150$  °C
- $V_{CE} = 600$  V
- $V_{GE} = \pm 15$  V
- $R_{gon} = 8$  Ω
- $R_{goff} = 8$  Ω

**Figure 10** Output inverter IGBT

Typical switching times as a function of gate resistor

$t = f(R_G)$



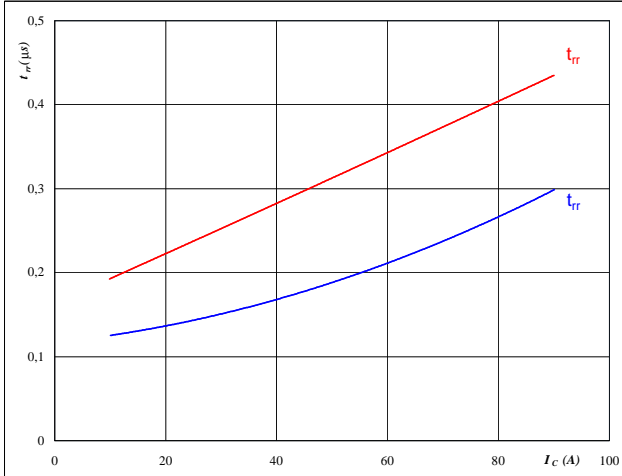
With an inductive load at

- $T_j = 150$  °C
- $V_{CE} = 600$  V
- $V_{GE} = \pm 15$  V
- $I_C = 50$  A

**Figure 11** Output inverter FWD

Typical reverse recovery time as a function of collector current

$t_{rr} = f(I_C)$



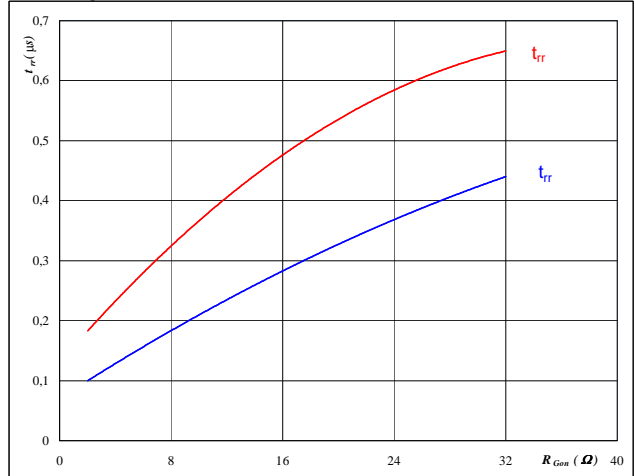
At

- $T_j = 25/150$  °C
- $V_{CE} = 600$  V
- $V_{GE} = \pm 15$  V
- $R_{gon} = 8$  Ω

**Figure 12** Output inverter FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$t_{rr} = f(R_{gon})$



At

- $T_j = 25/150$  °C
- $V_R = 600$  V
- $I_F = 50$  A
- $V_{GE} = \pm 15$  V



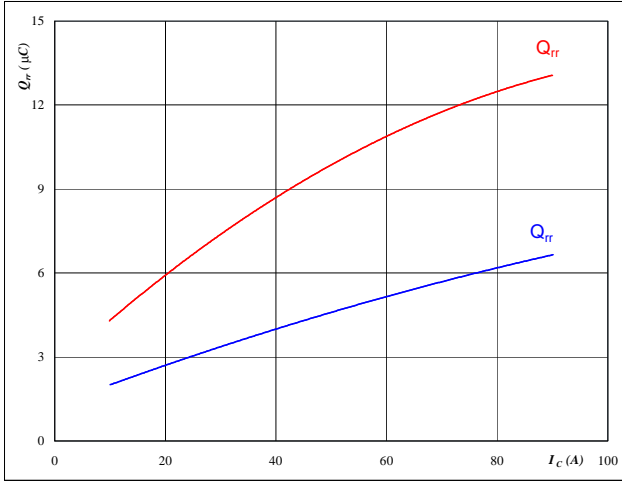


# Output Inverter

**Figure 13** Output inverter FWD

Typical reverse recovery charge as a function of collector current

$Q_{rr} = f(I_c)$

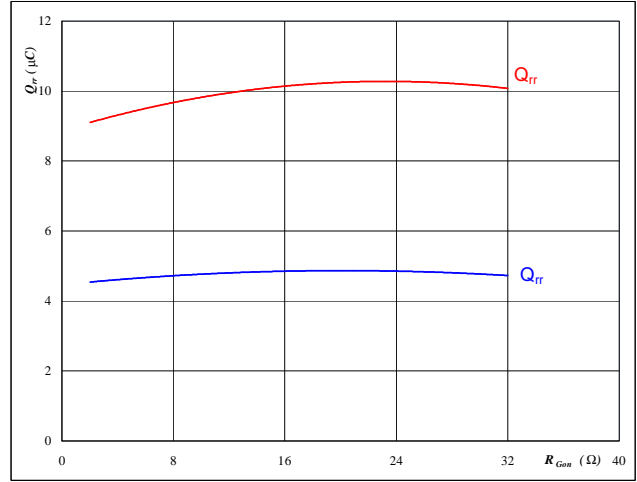


**At**  
 $T_j = 25/150$  °C  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 8$  Ω

**Figure 14** Output inverter FWD

Typical reverse recovery charge as a function of IGBT turn on gate resistor

$Q_{rr} = f(R_{gon})$

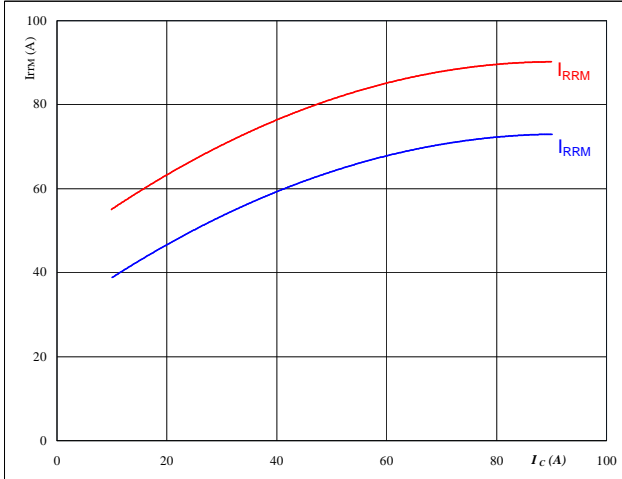


**At**  
 $T_j = 25/150$  °C  
 $V_R = 600$  V  
 $I_F = 50$  A  
 $V_{GE} = \pm 15$  V

**Figure 15** Output inverter FWD

Typical reverse recovery current as a function of collector current

$I_{RRM} = f(I_c)$

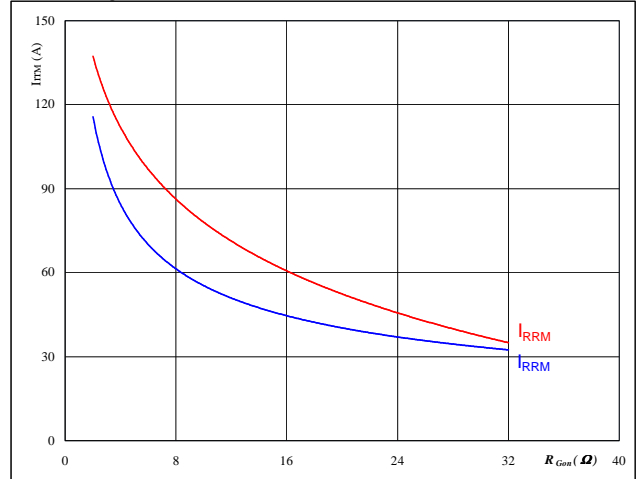


**At**  
 $T_j = 25/150$  °C  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 8$  Ω

**Figure 16** Output inverter FWD

Typical reverse recovery current as a function of IGBT turn on gate resistor

$I_{RRM} = f(R_{gon})$



**At**  
 $T_j = 25/150$  °C  
 $V_R = 600$  V  
 $I_F = 50$  A  
 $V_{GE} = \pm 15$  V

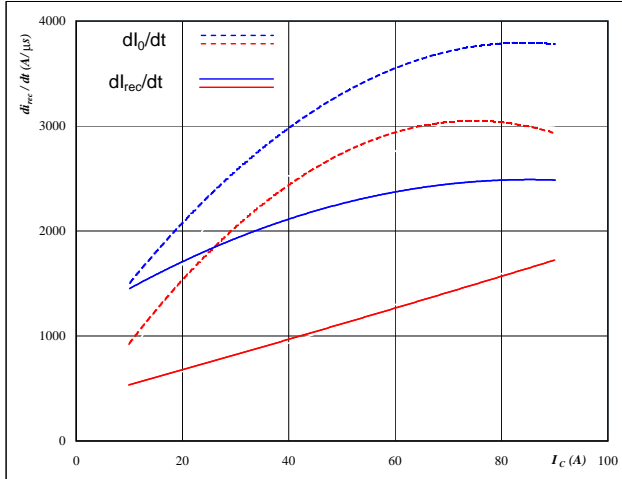


# Output Inverter

**Figure 17** Output inverter FWD

**Typical rate of fall of forward and reverse recovery current as a function of collector current**

$dI_0/dt, dI_{rec}/dt = f(I_C)$

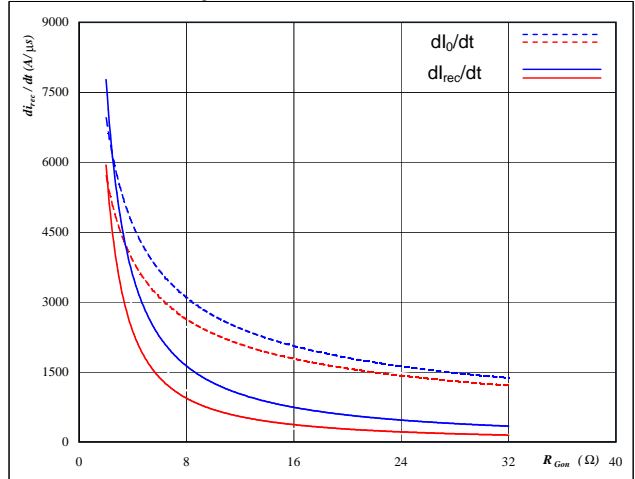


**At**  
 $T_j = 25/150$  °C  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 8$  Ω

**Figure 18** Output inverter FWD

**Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor**

$dI_0/dt, dI_{rec}/dt = f(R_{gon})$

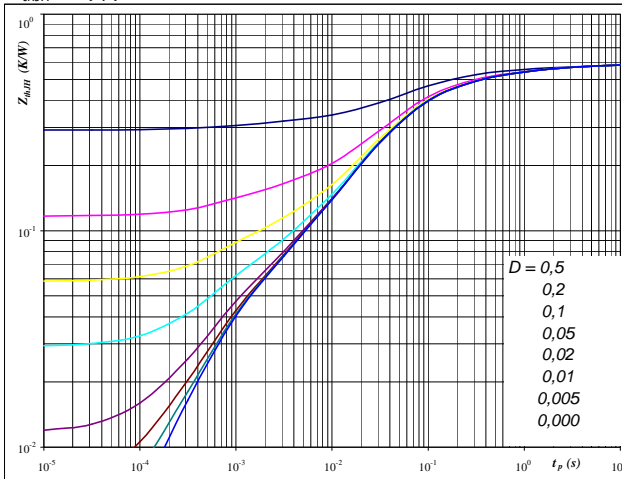


**At**  
 $T_j = 25/150$  °C  
 $V_R = 600$  V  
 $I_F = 50$  A  
 $V_{GE} = \pm 15$  V

**Figure 19** Output inverter IGBT

**IGBT transient thermal impedance as a function of pulse width**

$Z_{thJH} = f(tp)$



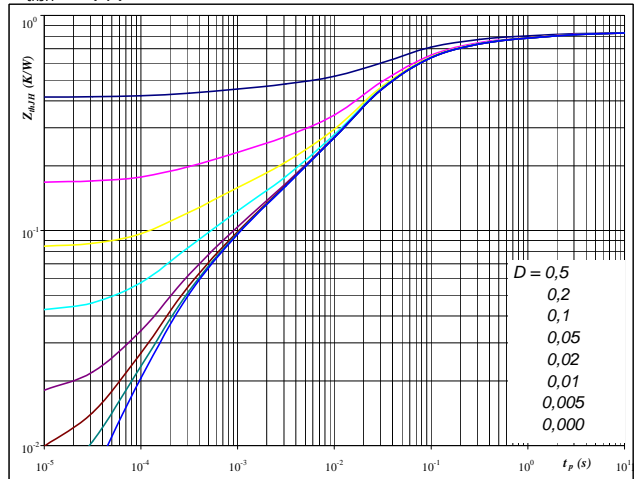
**At**  
 $D = tp / T$   
 $R_{thJH} = 0,583$  K/W       $R_{thJH} = 0,68$  K/W  
 Single device heated      All devices heated  
 IGBT thermal model values

R (K/W)	Tau (s)	R (K/W)	Tau (s)
0,07	2,1E+00	0,17	2,1E+00
0,13	2,4E-01	0,13	2,4E-01
0,27	5,1E-02	0,27	5,1E-02
0,08	1,2E-02	0,08	1,2E-02
0,04	8,6E-04	0,04	8,6E-04

**Figure 20** Output inverter FWD

**FWD transient thermal impedance as a function of pulse width**

$Z_{thJH} = f(tp)$



**At**  
 $D = tp / T$   
 $R_{thJH} = 0,83$  K/W       $R_{thJH} = 0,83$  K/W  
 Single device heated      All devices heated  
 FWD thermal model values

R (K/W)	Tau (s)	R (K/W)	Tau (s)
0,02	9,7E+00	0,02	9,7E+00
0,08	1,1E+00	0,08	1,1E+00
0,22	1,3E-01	0,22	1,3E-01
0,39	2,5E-02	0,39	2,5E-02
0,07	2,0E-03	0,07	2,0E-03
0,05	2,9E-04	0,05	2,9E-04

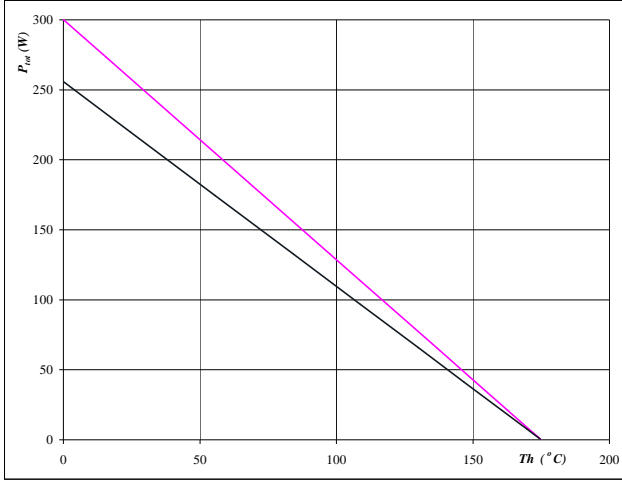


# Output Inverter

**Figure 21** Output inverter IGBT

**Power dissipation as a function of heatsink temperature**

$P_{tot} = f(T_h)$

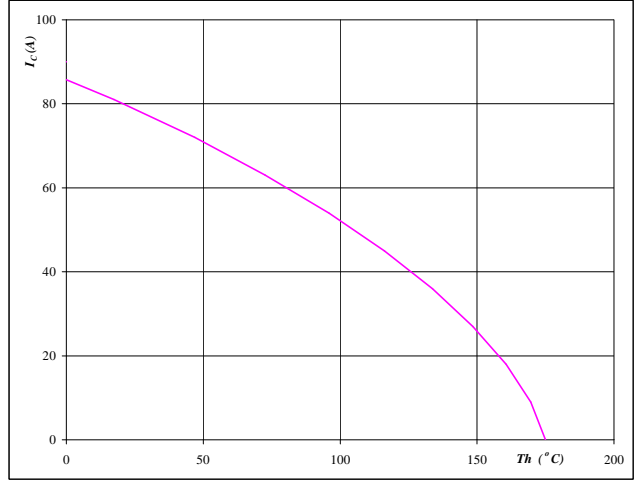


**At**  
 $T_j = 175$  °C  
— single heating  
— overall heating

**Figure 22** Output inverter IGBT

**Collector current as a function of heatsink temperature**

$I_C = f(T_h)$

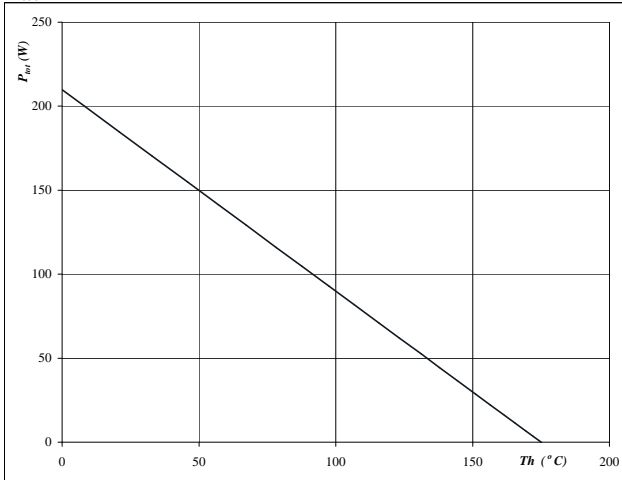


**At**  
 $T_j = 175$  °C  
 $V_{GE} = 15$  V

**Figure 23** Output inverter FWD

**Power dissipation as a function of heatsink temperature**

$P_{tot} = f(T_h)$

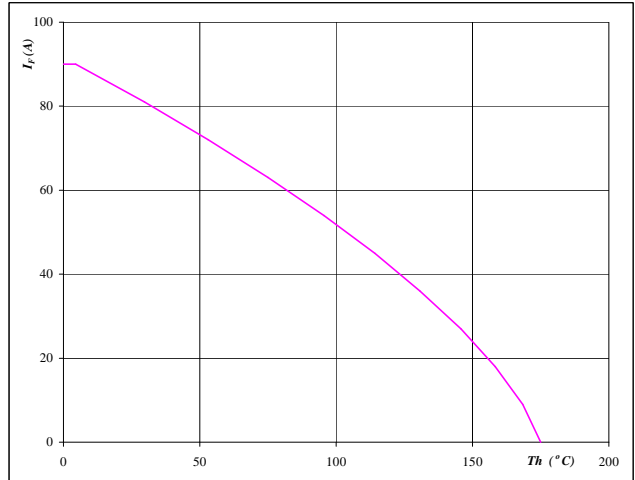


**At**  
 $T_j = 175$  °C

**Figure 24** Output inverter FWD

**Forward current as a function of heatsink temperature**

$I_F = f(T_h)$



**At**  
 $T_j = 175$  °C

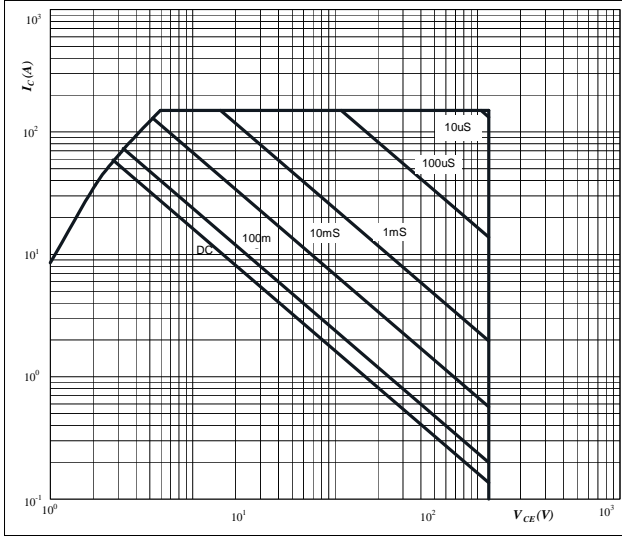


# Output Inverter

**Figure 25** Output inverter IGBT

Safe operating area as a function of collector-emitter voltage

$I_C = f(V_{CE})$

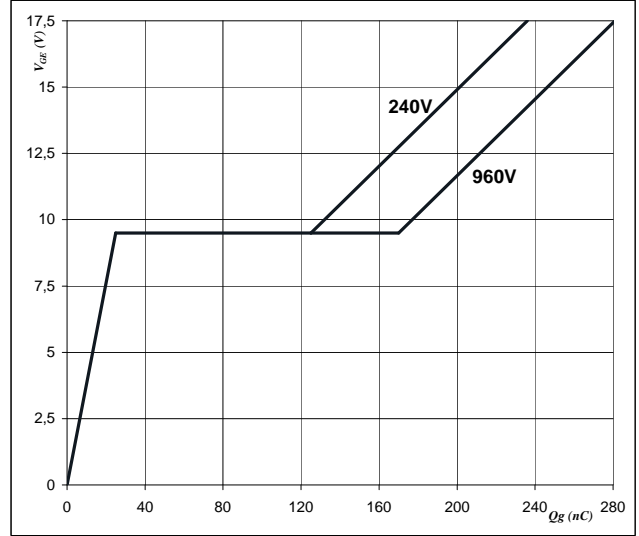


**At**  
 D = single pulse  
 Th = 80 °C  
 V<sub>GE</sub> = ±15 V  
 Tj = T<sub>jmax</sub> °C

**Figure 26** Output inverter IGBT

Gate voltage vs Gate charge

$V_{GE} = f(Q_g)$



**At**  
 I<sub>C</sub> = 50 A

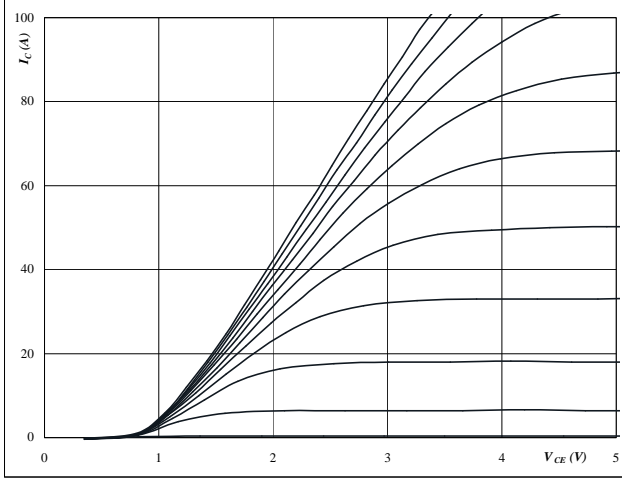


# Brake

**Figure 1** Brake IGBT

**Typical output characteristics**

$I_C = f(V_{CE})$

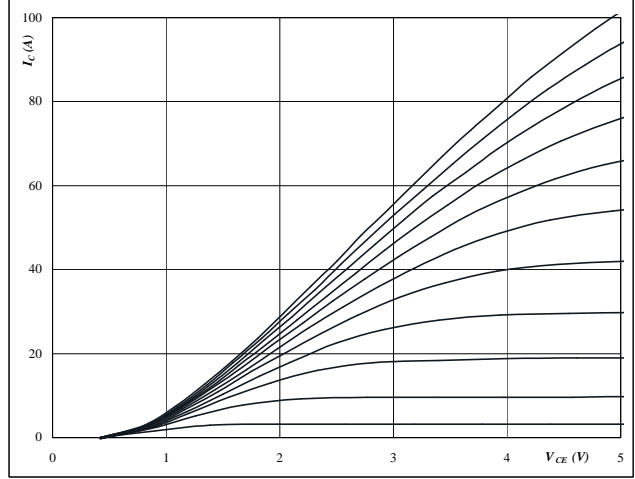


**At**  
 $t_p = 250 \mu s$   
 $T_j = 25 \text{ }^\circ C$   
V<sub>GE</sub> from 7 V to 17 V in steps of 1 V

**Figure 2** Brake IGBT

**Typical output characteristics**

$I_C = f(V_{CE})$

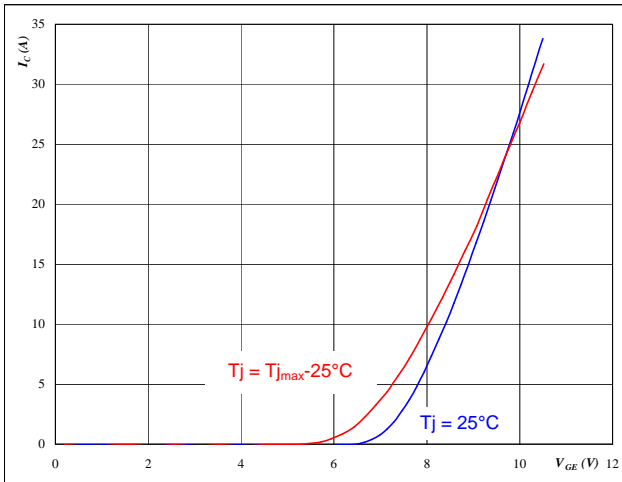


**At**  
 $t_p = 250 \mu s$   
 $T_j = 150 \text{ }^\circ C$   
V<sub>GE</sub> from 7 V to 17 V in steps of 1 V

**Figure 3** Brake IGBT

**Typical transfer characteristics**

$I_C = f(V_{GE})$

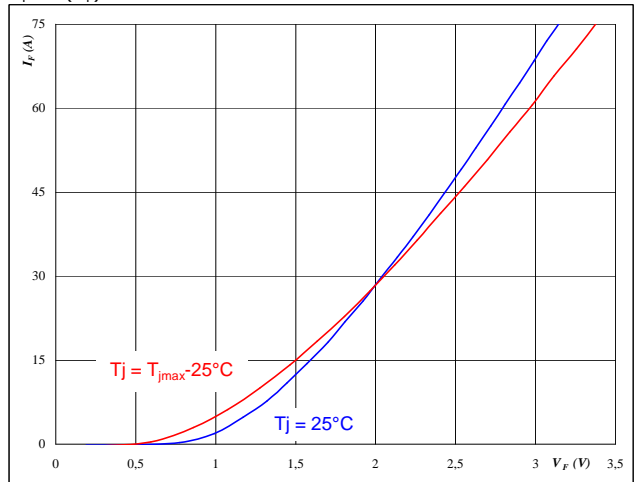


**At**  
 $t_p = 250 \mu s$   
 $V_{CE} = 10 V$

**Figure 4** Brake FWD

**Typical diode forward current as a function of forward voltage**

$I_F = f(V_F)$



**At**  
 $t_p = 250 \mu s$

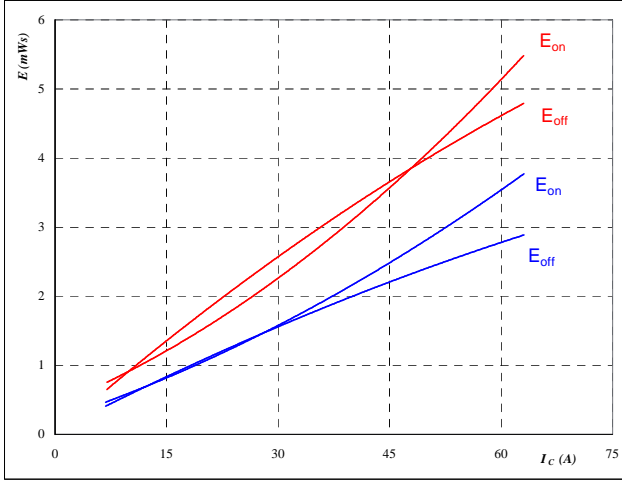


# Brake

**Figure 5** Brake IGBT

**Typical switching energy losses as a function of collector current**

$E = f(I_C)$



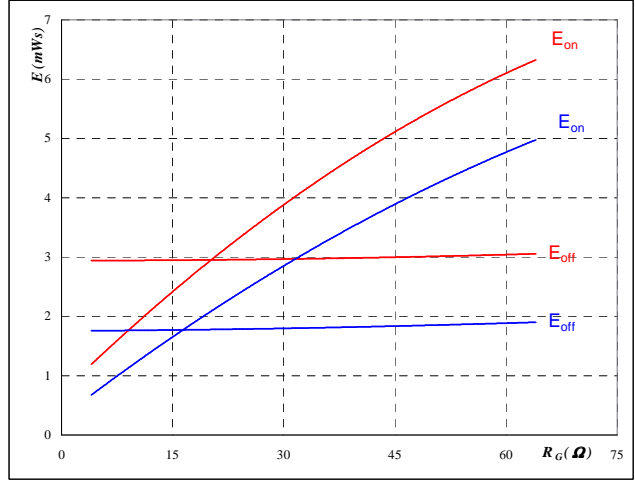
With an inductive load at

- $T_j = 25/150$  °C
- $V_{CE} = 600$  V
- $V_{GE} = \pm 15$  V
- $R_{gon} = 16$  Ω
- $R_{goff} = 16$  Ω

**Figure 6** Brake IGBT

**Typical switching energy losses as a function of gate resistor**

$E = f(R_G)$



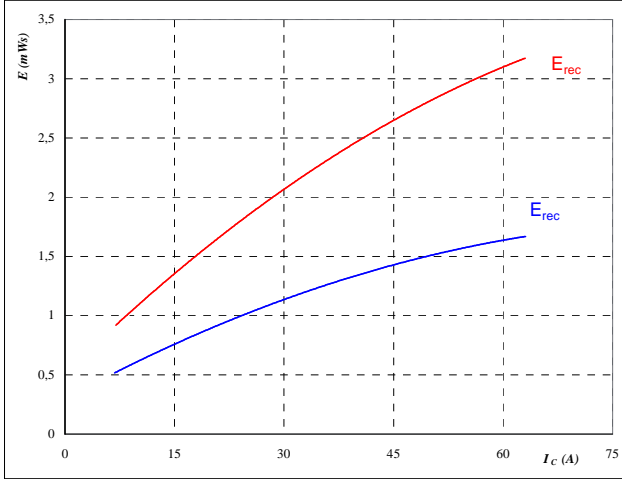
With an inductive load at

- $T_j = 25/150$  °C
- $V_{CE} = 600$  V
- $V_{GE} = \pm 15$  V
- $I_C = 35$  A

**Figure 7** Brake IGBT

**Typical reverse recovery energy loss as a function of collector current**

$E_{rec} = f(I_C)$



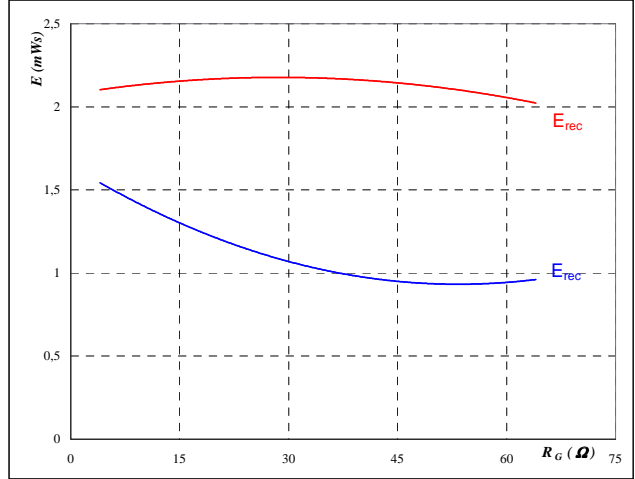
With an inductive load at

- $T_j = 25/150$  °C
- $V_{CE} = 600$  V
- $V_{GE} = \pm 15$  V
- $R_{gon} = 16$  Ω

**Figure 8** Brake IGBT

**Typical reverse recovery energy loss as a function of gate resistor**

$E_{rec} = f(R_G)$



With an inductive load at

- $T_j = 25/150$  °C
- $V_{CE} = 600$  V
- $V_{GE} = \pm 15$  V
- $I_C = 35$  A

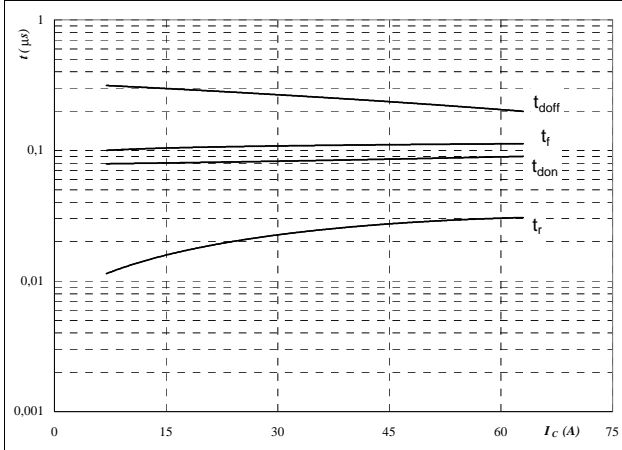


# Brake

**Figure 9** Brake IGBT

Typical switching times as a function of collector current

$t = f(I_C)$

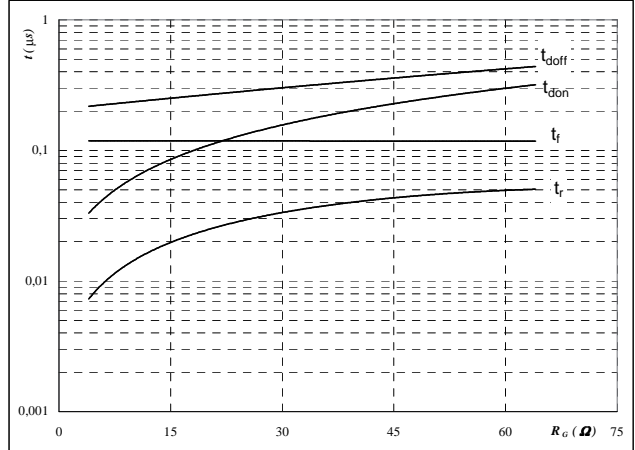


With an inductive load at  
 $T_j = 150 \text{ } ^\circ\text{C}$   
 $V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 16 \text{ } \Omega$   
 $R_{goff} = 16 \text{ } \Omega$

**Figure 10** Brake IGBT

Typical switching times as a function of gate resistor

$t = f(R_G)$

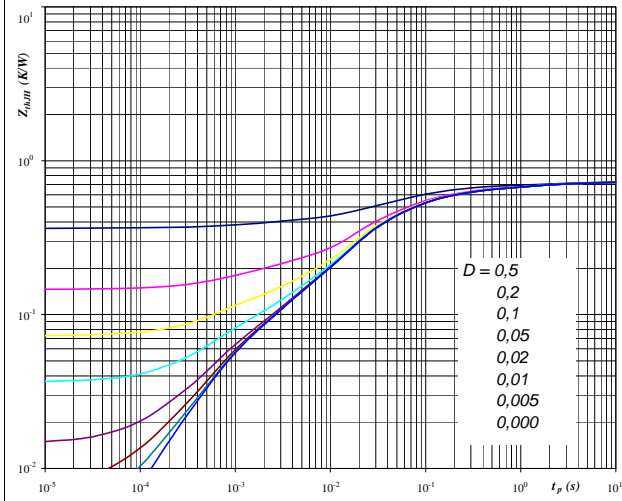


With an inductive load at  
 $T_j = 150 \text{ } ^\circ\text{C}$   
 $V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 35 \text{ A}$

**Figure 11** Brake IGBT

IGBT transient thermal impedance as a function of pulse width

$Z_{thJH} = f(t_p)$

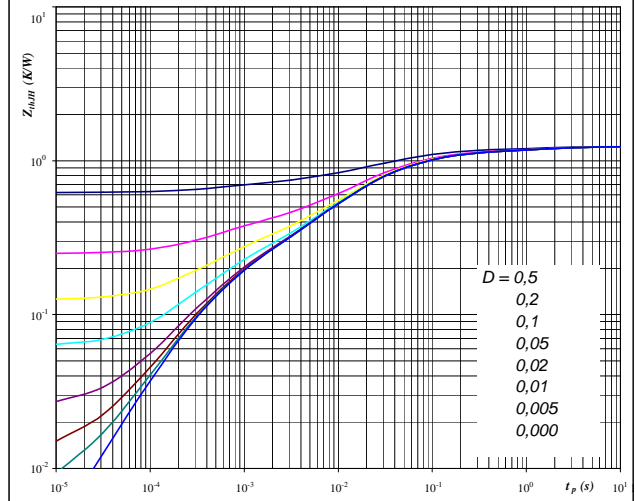


**At**  
 $D = t_p / T$   
 $R_{thJH} = 0,73 \text{ K/W}$

**Figure 12** Brake IGBT

FWD transient thermal impedance as a function of pulse width

$Z_{thJH} = f(t_p)$



**At**  
 $D = t_p / T$   
 $R_{thJH} = 1,24 \text{ K/W}$

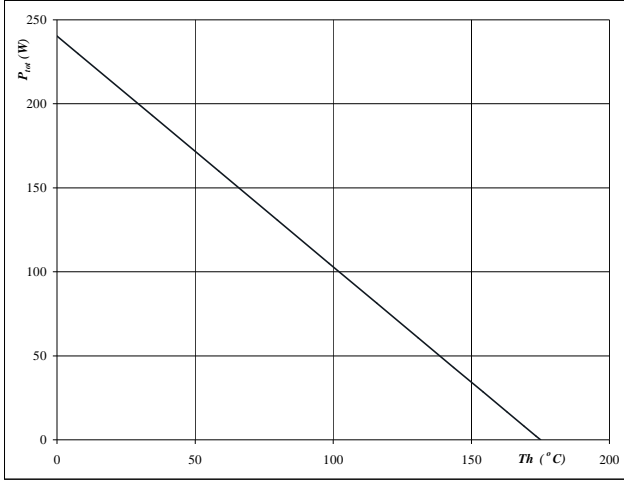


# Brake

**Figure 13** Brake IGBT

**Power dissipation as a function of heatsink temperature**

$P_{tot} = f(T_h)$

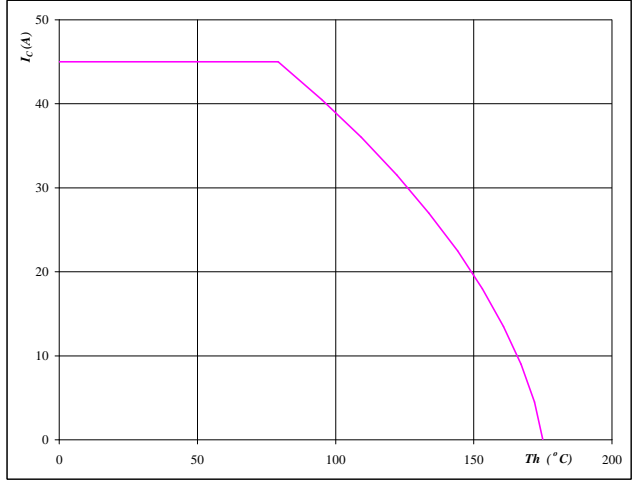


**At**  
T<sub>j</sub> = 175 °C

**Figure 14** Brake IGBT

**Collector current as a function of heatsink temperature**

$I_C = f(T_h)$

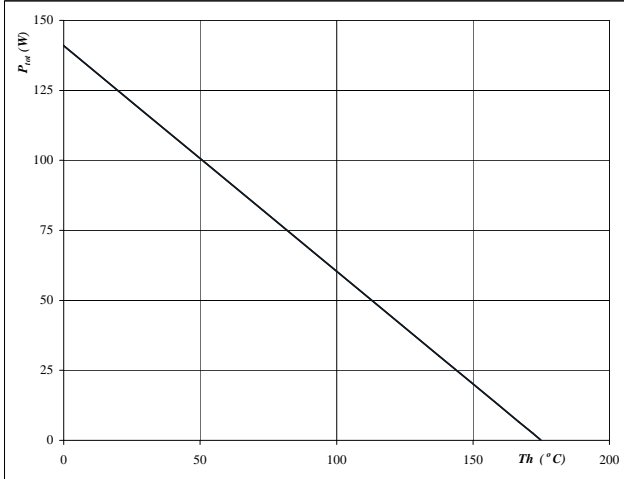


**At**  
T<sub>j</sub> = 175 °C  
V<sub>GE</sub> = 15 V

**Figure 15** Brake FWD

**Power dissipation as a function of heatsink temperature**

$P_{tot} = f(T_h)$

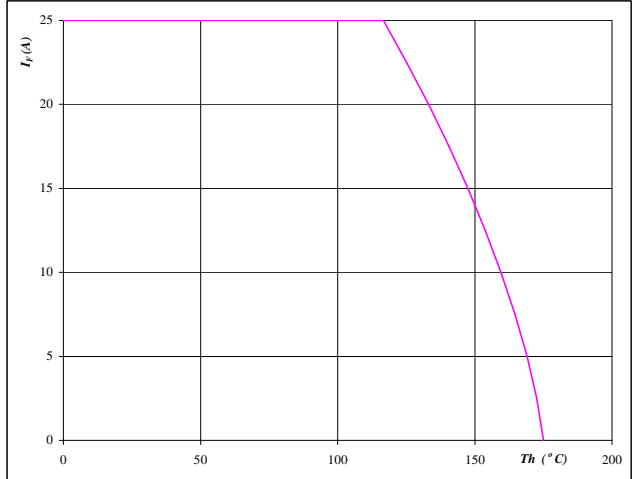


**At**  
T<sub>j</sub> = 175 °C

**Figure 16** Brake FWD

**Forward current as a function of heatsink temperature**

$I_F = f(T_h)$



**At**  
T<sub>j</sub> = 175 °C



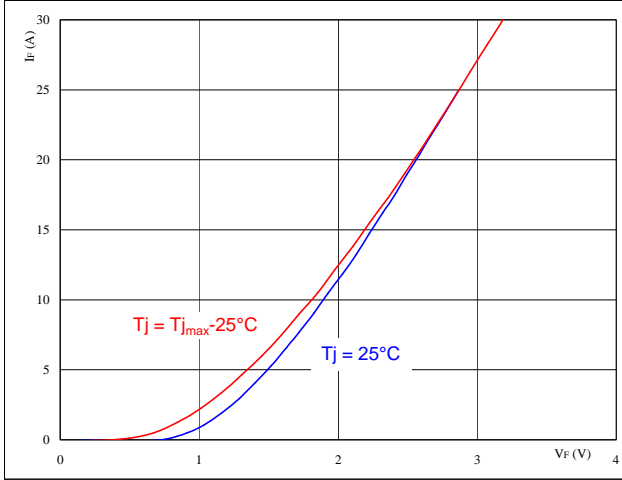


# Brake Inverse Diode

**Figure 1** Brake inverse diode

Typical diode forward current as a function of forward voltage

$$I_F = f(V_F)$$

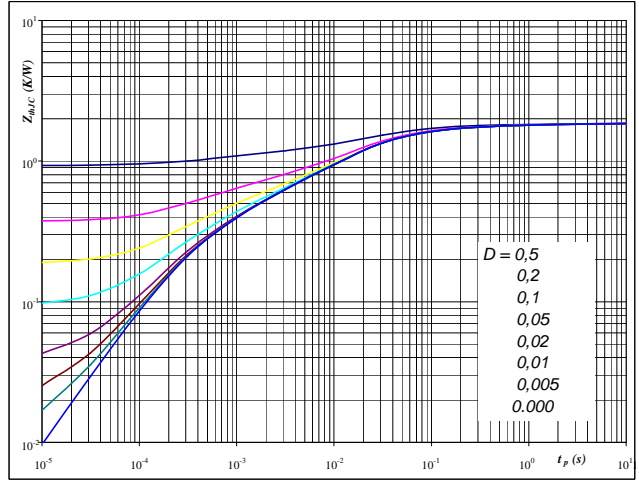


**At**  
 $t_p = 250 \mu s$

**Figure 2** Brake inverse diode

Diode transient thermal impedance as a function of pulse width

$$Z_{thJC} = f(t_p)$$

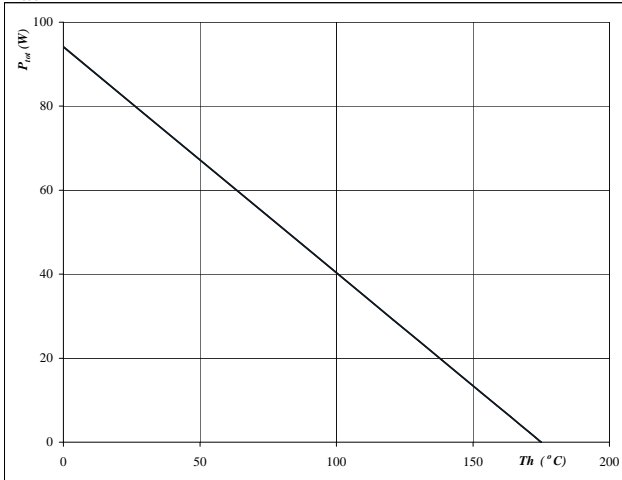


**At**  
 $D = t_p / T$   
 $R_{thJH} = 1,86 \text{ K/W}$

**Figure 3** Brake inverse diode

Power dissipation as a function of heatsink temperature

$$P_{tot} = f(T_h)$$

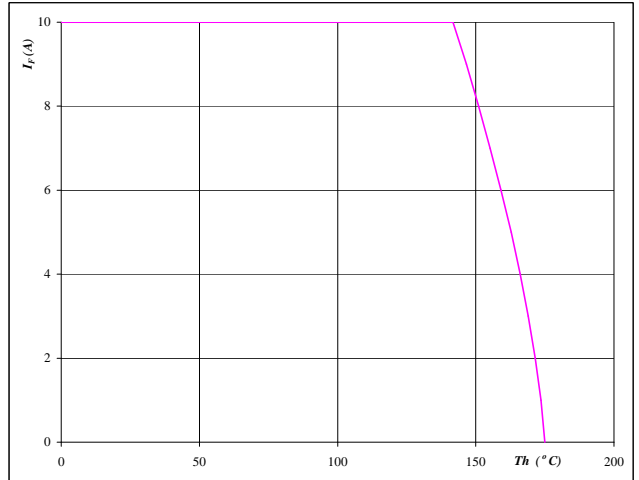


**At**  
 $T_j = 175 \text{ °C}$

**Figure 4** Brake inverse diode

Forward current as a function of heatsink temperature

$$I_F = f(T_h)$$



**At**  
 $T_j = 175 \text{ °C}$

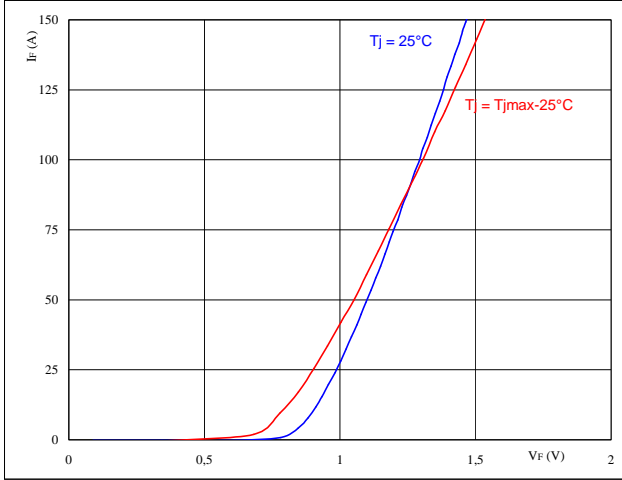


# Input Rectifier Bridge

**Figure 1** Rectifier diode

Typical diode forward current as a function of forward voltage

$$I_F = f(V_F)$$

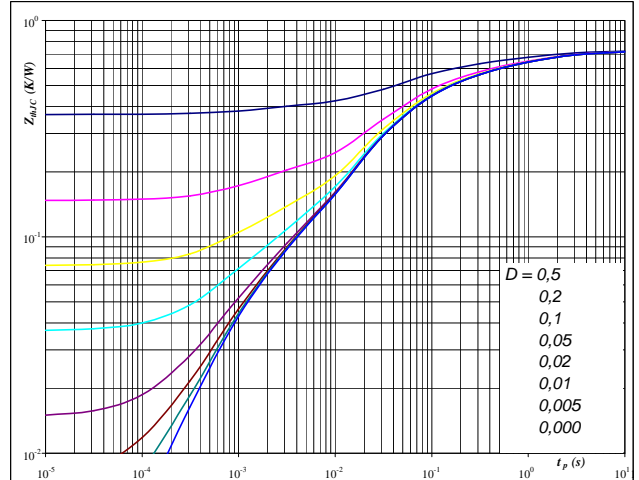


**At**  
 $t_p = 250 \mu s$

**Figure 2** Rectifier diode

Diode transient thermal impedance as a function of pulse width

$$Z_{thJH} = f(t_p)$$

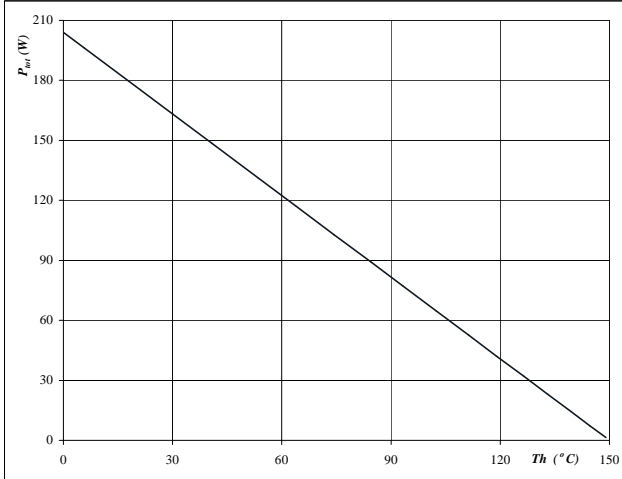


**At**  
 $D = t_p / T$   
 $R_{thJH} = 0,74 \text{ K/W}$

**Figure 3** Rectifier diode

Power dissipation as a function of heatsink temperature

$$P_{tot} = f(T_h)$$

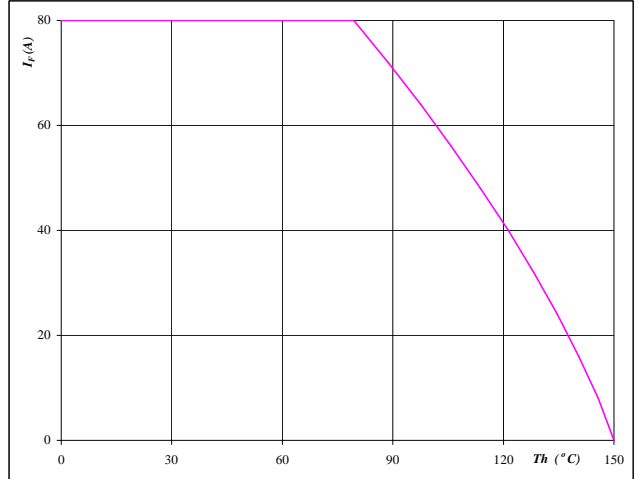


**At**  
 $T_j = 150 \text{ °C}$

**Figure 4** Rectifier diode

Forward current as a function of heatsink temperature

$$I_F = f(T_h)$$



**At**  
 $T_j = 150 \text{ °C}$

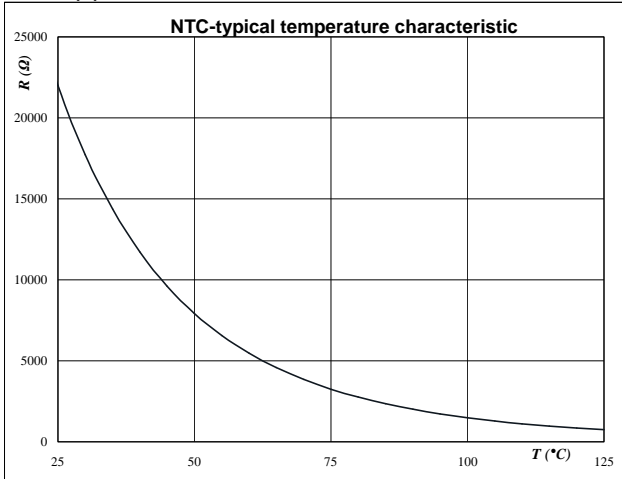


# Thermistor

**Figure 1** Thermistor

**Typical NTC characteristic  
as a function of temperature**

$$R_T = f(T)$$





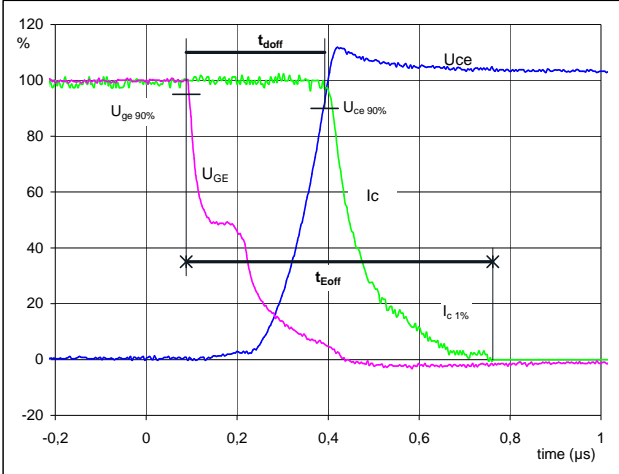
# Switching Definitions Output Inverter

**General conditions**

$T_j$	=	150 °C
$R_{gon}$	=	8 $\Omega$
$R_{goff}$	=	8 $\Omega$

**Figure 1** Output inverter IGBT

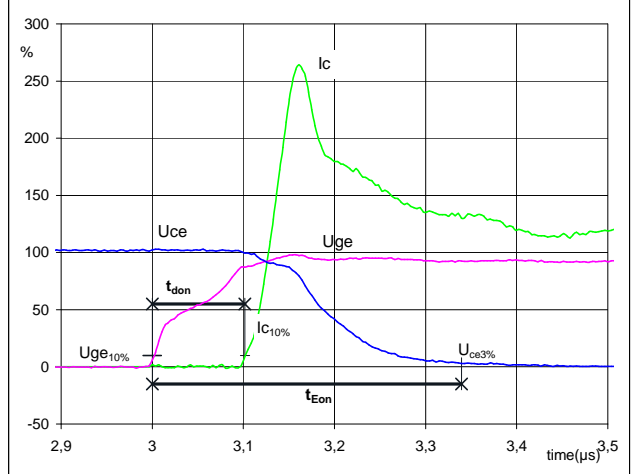
**Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$**   
( $t_{Eoff}$  = integrating time for  $E_{off}$ )



$V_{GE}(0\%)$	=	-15	V
$V_{GE}(100\%)$	=	15	V
$V_C(100\%)$	=	600	V
$I_C(100\%)$	=	50	A
$t_{doff}$	=	0,30	$\mu s$
$t_{Eoff}$	=	0,67	$\mu s$

**Figure 2** Output inverter IGBT

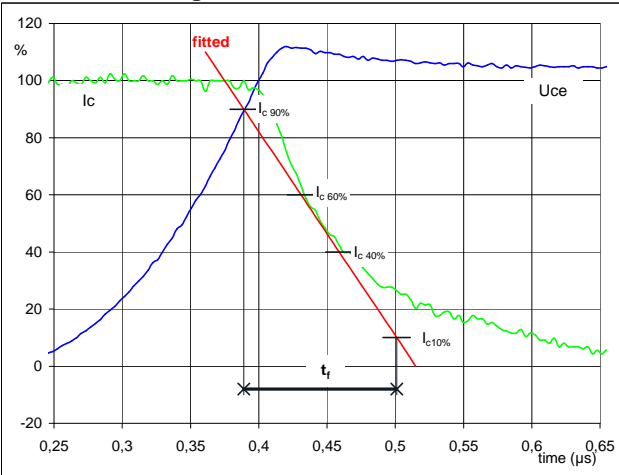
**Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$**   
( $t_{Eon}$  = integrating time for  $E_{on}$ )



$V_{GE}(0\%)$	=	-15	V
$V_{GE}(100\%)$	=	15	V
$V_C(100\%)$	=	600	V
$I_C(100\%)$	=	50	A
$t_{don}$	=	0,10	$\mu s$
$t_{Eon}$	=	0,34	$\mu s$

**Figure 3** Output inverter IGBT

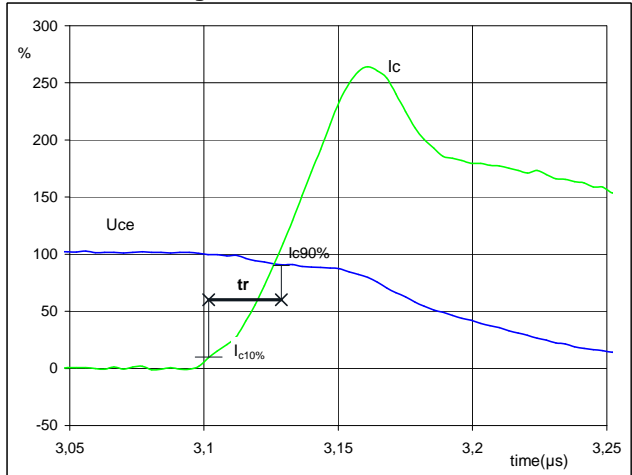
**Turn-off Switching Waveforms & definition of  $t_r$**



$V_C(100\%)$	=	600	V
$I_C(100\%)$	=	50	A
$t_r$	=	0,12	$\mu s$

**Figure 4** Output inverter IGBT

**Turn-on Switching Waveforms & definition of  $t_r$**

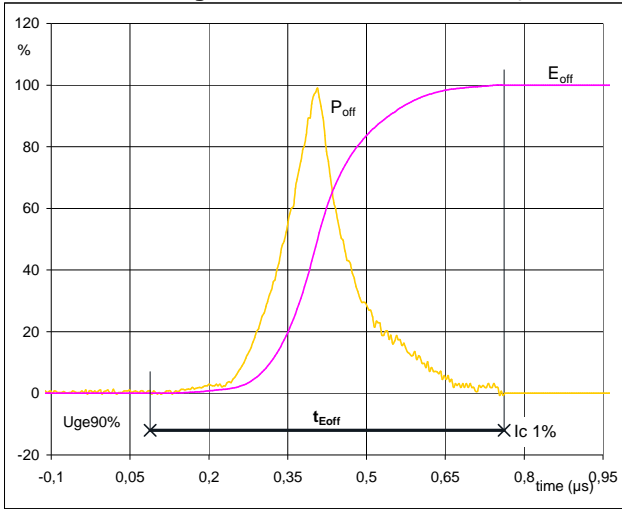


$V_C(100\%)$	=	600	V
$I_C(100\%)$	=	50	A
$t_r$	=	0,02	$\mu s$



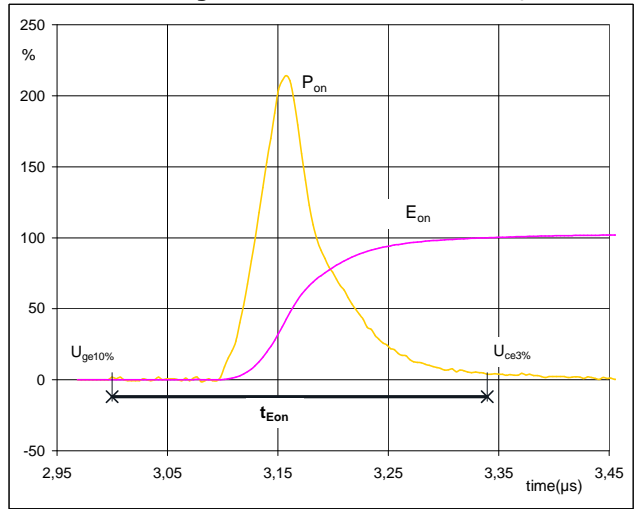
# Switching Definitions Output Inverter

**Figure 5** Output inverter IGBT  
**Turn-off Switching Waveforms & definition of  $t_{Eoff}$**



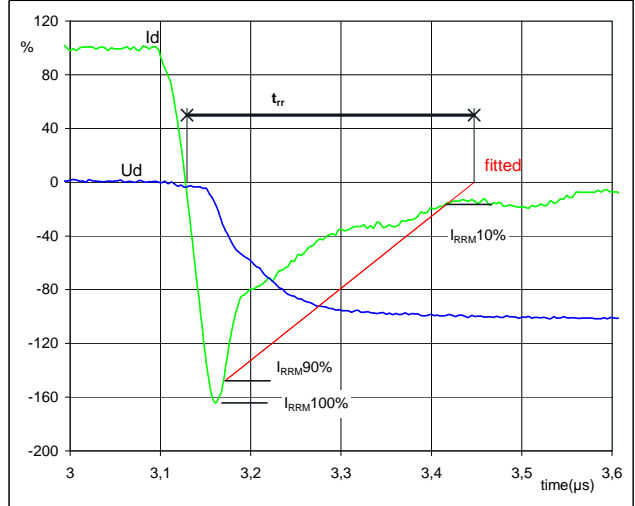
$P_{off} (100\%) = 29,95 \text{ kW}$   
 $E_{off} (100\%) = 4,48 \text{ mJ}$   
 $t_{Eoff} = 0,67 \text{ μs}$

**Figure 6** Output inverter IGBT  
**Turn-on Switching Waveforms & definition of  $t_{Eon}$**



$P_{on} (100\%) = 29,95 \text{ kW}$   
 $E_{on} (100\%) = 4,50 \text{ mJ}$   
 $t_{Eon} = 0,34 \text{ μs}$

**Figure 7** Output inverter FWD  
**Turn-off Switching Waveforms & definition of  $t_{rr}$**

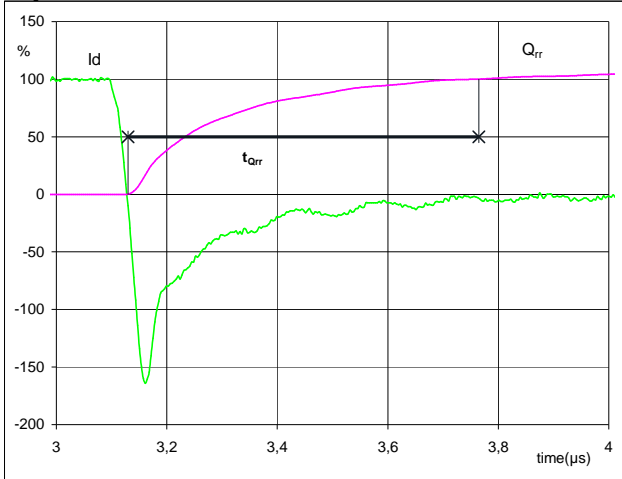


$V_d (100\%) = 600 \text{ V}$   
 $I_d (100\%) = 50 \text{ A}$   
 $I_{RRM} (100\%) = -82 \text{ A}$   
 $t_{rr} = 0,31 \text{ μs}$



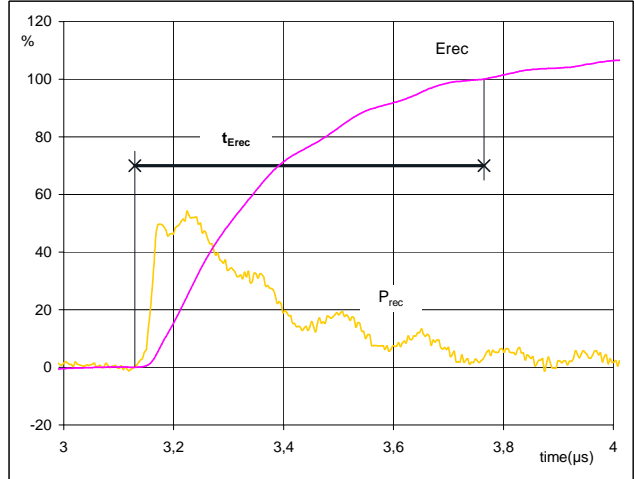
# Switching Definitions Output Inverter

**Figure 8** Output inverter FWD  
Turn-on Switching Waveforms & definition of  $t_{Qrr}$   
( $t_{Qrr}$  = integrating time for  $Q_{rr}$ )



$I_d$ (100%) =	50	A
$Q_{rr}$ (100%) =	9,95	$\mu C$
$t_{Qint}$ =	0,64	$\mu s$

**Figure 9** Output inverter FWD  
Turn-on Switching Waveforms & definition of  $t_{Erec}$   
( $t_{Erec}$  = integrating time for  $E_{rec}$ )



$P_{rec}$ (100%) =	29,95	kW
$E_{rec}$ (100%) =	3,98	mJ
$t_{Erec}$ =	0,64	$\mu s$

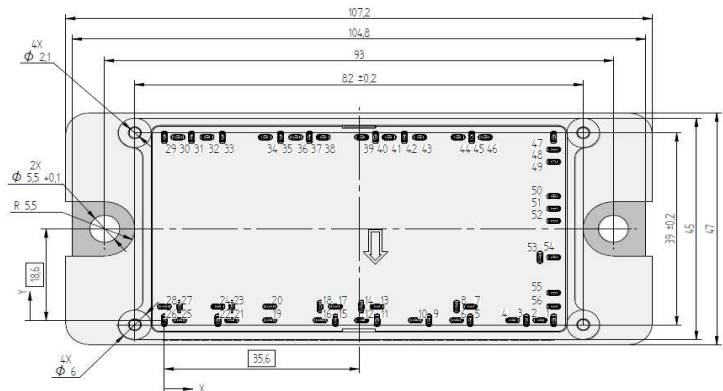


### Ordering Code & Marking

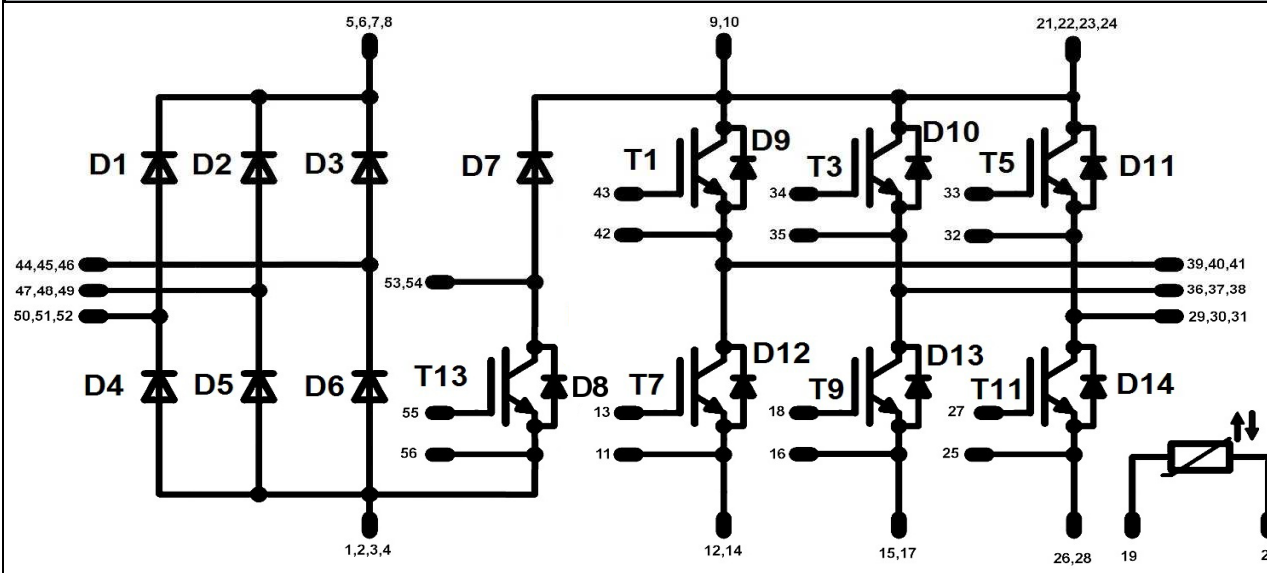
Version	Ordering Code	in DataMatrix as	in packaging barcode as
without thermal paste with solder pins	V23990-P768-A-PM	P768A	P768A
without thermal paste with Press-fit pins	V23990-P768-AY-PM	P768AY	P768AY
with thermal paste with solder pins	V23990-P768-A-/3/-PM	P768A	P768A-/3/
with thermal paste with Press-fit pins	V23990-P768-AY-/3/-PM	P768AY	P768AY-/3/

### Outline

Pin table							
Pin		X	Y	Pin	X	Y	
1	DC-	71,2	0	30	U	2,5	37,2
2	DC-	68,7	0	31	U	5	37,2
3	DC-	66,2	0	32	E	7,8	37,2
4	DC-	63,7	0	33	G	10,6	37,2
5	DC+	55,95	0	34	G	18,45	37,2
6	DC+	53,45	0	35	E	21,25	37,2
7	DC+	55,95	2,8	36	V	24,05	37,2
8	DC+	53,45	2,8	37	V	26,55	37,2
9	DC+	48,4	0	38	V	29,05	37,2
10	DC+	45,9	0	39	W	36,1	37,2
11	E	38,9	0	40	W	38,6	37,2
12	DC-	36,1	0	41	W	41,1	37,2
13	G	38,9	2,8	42	E	43,9	37,2
14	DC-	36,1	2,8	43	G	46,7	37,2
15	DC-	31,3	0	44	L1	53,7	37,2
16	E	28,5	0	45	L1	56,2	37,2
17	DC-	31,3	2,8	46	L1	58,7	37,2
18	G	28,5	2,8	47	L2	71,2	37,2
19	R1	19,3	0	48	L2	71,2	34,7
20	R2	19,3	2,8	49	L2	71,2	32,2
21	DC+	12,3	0	50	L3	71,2	25,2
22	DC+	9,8	0	51	L3	71,2	22,7
23	DC+	12,3	2,8	52	L3	71,2	20,2
24	DC+	9,8	2,8	53	BrC	71,2	12,8
25	E	2,8	0	54	BrC	68,7	12,8
26	DC-	0	0	55	BrG	71,2	5,6
27	G	2,8	2,8	56	BrE	71,2	2,8
28	DC-	0	2,8				
29	U	0	37,2				



### Pinout



### Identification

ID	Component	Voltage	Current	Function	Comment
T1,T3,T5 T7,T9,T11	IGBT	1200V	50A	Inverter Switch	
D9,D10,D11, D12,D13,D14	FWD	1200V	50A	Inverter Diode	
T13	IGBT	1200V	50A	Brake Switch	
D7	FWD	1200V	25A	Brake Diode	
D8	FWD	1200V	10A	Brake Protection Diode	
D1,D2,D3,D4,D5,D6	Rectifier	1600V	50A	Rectifier	
NTC	NTC	-	-	Thermistor	

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.